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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, WDT
Number of I/O	18
Program Memory Size	2KB (2K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/p87lpc762bdh-512

# Low power, low price, low pin count (20 pin) microcontroller with 2 kbyte OTP

### 87LPC762

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#### **GENERAL DESCRIPTION**

The 87LPC762 is a 20-pin single-chip microcontroller designed for low pin count applications demanding high-integration, low cost solutions over a wide range of performance requirements. A member of the Philips low pin count family, the 87LPC762 offers programmable oscillator configurations for high and low speed crystals or RC operation, wide operating voltage range, programmable port output configurations, selectable Schmitt trigger inputs, LED drive outputs, and a built-in watchdog timer. The 87LPC762 is based on an accelerated 80C51 processor architecture that executes instructions at twice the rate of standard 80C51 devices.

#### **FEATURES**

- An accelerated 80C51 CPU provides instruction cycle times of 300–600ns for all instructions except multiply and divide when executing at 20 MHz. Execution at up to 20 MHz when V<sub>DD</sub> = 4.5 V to 6.0 V, 10 MHz when V<sub>DD</sub> = 2.7 V to 6.0 V.
- 2.7 V to 6.0 V operating range for digital functions.
- 2 kbytes EPROM code memory.
- 128 byte RAM data memory.
- 32-byte customer code EPROM allows serialization of devices, storage of setup parameters, etc.
- Two 16-bit counter/timers. Each timer may be configured to toggle a port output upon timer overflow.
- Two analog comparators.
- Full duplex UART.
- I<sup>2</sup>C communication port.

- Eight keypad interrupt inputs, plus two additional external interrupt inputs.
- Four interrupt priority levels.
- Watchdog timer with separate on-chip oscillator, requiring no external components. The watchdog timeout time is selectable from 8 values.
- Active low reset. On-chip power-on reset allows operation with no external reset components.
- Low voltage reset. One of two preset low voltage levels may be selected to allow a graceful system shutdown when power fails.
   May optionally be configured as an interrupt.
- Oscillator Fail Detect. The watchdog timer has a separate fully on-chip oscillator, allowing it to perform an oscillator fail detect function.
- Configurable on-chip oscillator with frequency range and RC oscillator options (selected by user programmed EPROM bits).
   The RC oscillator option allows operation with no external oscillator components.
- Programmable port output configuration options: quasi-bidirectional, open drain, push-pull, input-only.
- Selectable Schmitt trigger port inputs.
- LED drive capability (20 mA) on all port pins.
- Controlled slew rate port outputs to reduce EMI. Outputs have approximately 10 ns minimum ramp times.
- 15 I/O pins minimum. Up to 18 I/O pins using on-chip oscillator and reset options.
- Only power and ground connections are required to operate the 87LPC762 when fully on-chip oscillator and reset options are selected.
- Serial EPROM programming allows simple in-circuit production coding. Two EPROM security bits prevent reading of sensitive application programs.
- Idle and Power Down reduced power modes. Improved wakeup from Power Down mode (a low interrupt input starts execution).
   Typical Power Down current is 1 μA.
- 20-pin DIP, SO, and TSSOP packages.

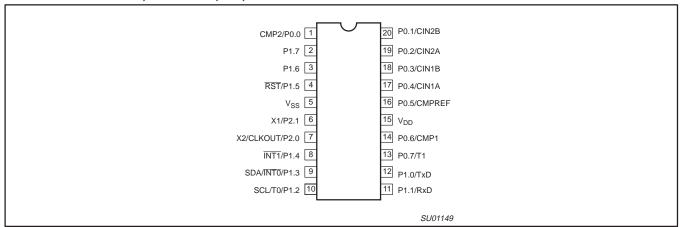
#### ORDERING INFORMATION

Part Number	Temperature Range °C and Package	Frequency	Drawing Number
P87LPC762BN	0 to +70, Plastic Dual In-Line Package	20 MHz (5 V), 10 MHz (3 V)	SOT146-1
P87LPC762BD	0 to +70, Plastic Small Outline Package	20 MHz (5 V), 10 MHz (3 V)	SOT163-1
P87LPC762FN	–45 to +85, Plastic Dual In-Line Package	20 MHz (5 V), 10 MHz (3 V)	SOT146-1
P87LPC762FD	-45 to +85, Plastic Small Outline Package	20 MHz (5 V), 10 MHz (3 V)	SOT163-1
P87LPC762BDH	0 to +70, Plastic Thin Small Outline Package	20 MHz (5 V), 10 MHz (3 V)	SOT360-1

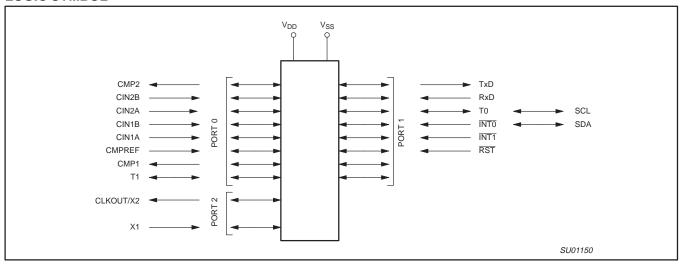
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### PIN CONFIGURATION, 20-PIN DIP, SO, AND TSSOP PACKAGES



### **LOGIC SYMBOL**



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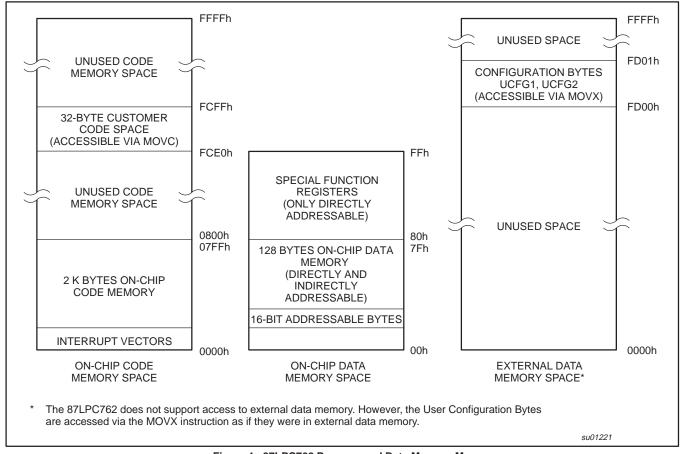


Figure 1. 87LPC762 Program and Data Memory Map

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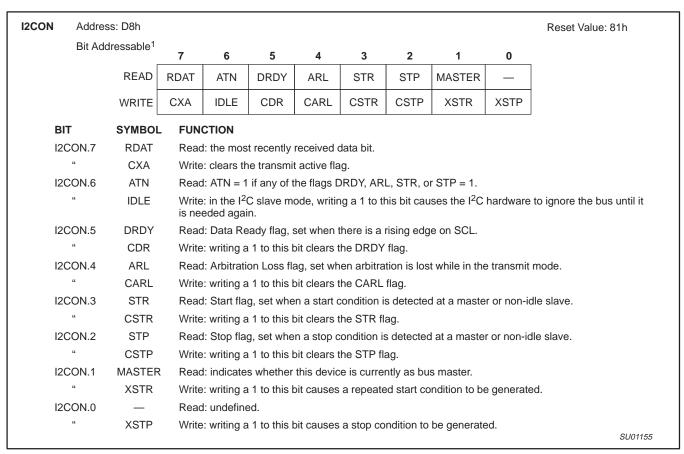


Figure 6. I<sup>2</sup>C Control Register (I2CON)

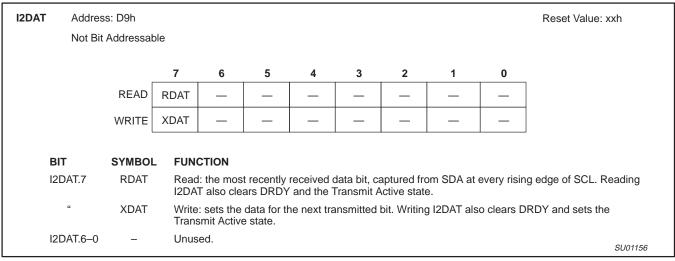


Figure 7. I<sup>2</sup>C Data Register (I2DAT)

#### **Checking ATN and DRDY**

When a program detects ATN = 1, it should next check DRDY. If DRDY = 1, then if it receives the last bit, it should capture the data from RDAT (in I2DAT or I2CON). Next, if the next bit is to be sent, it should be written to I2DAT. One way or another, it should clear DRDY and then return to monitoring ATN. Note that if any of ARL,

STR, or STP is set, clearing DRDY will not release SCL to high, so that the  $I^2C$  will not go on to the next bit. If a program detects ATN = 1, and DRDY = 0, it should go on to examine ARL, STR, and STP.

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#### Oscillator

The 87LPC762 provides several user selectable oscillator options, allowing optimization for a range of needs from high precision to lowest possible cost. These are configured when the EPROM is

programmed. Basic oscillator types that are supported include: low, medium, and high speed crystals, covering a range from 20 kHz to 20 MHz; ceramic resonators; and on-chip RC oscillator.

#### **Low Frequency Oscillator Option**

This option supports an external crystal in the range of 20 kHz to 100 kHz.

Table 5 shows capacitor values that may be used with a quartz crystal in this mode.

Table 5. Recommended oscillator capacitors for use with the low frequency oscillator option

Oscillator		V <sub>DD</sub> = 2.7 to 4.5 V		V <sub>DD</sub> = 4.5 to 6.0 V			
Frequency	Lower Limit	Optimal Value	Upper Limit	Lower Limit	Optimal Value	Upper Limit	
20 kHz	15 pF	15 pF	33 pF	33 pF	33 pF	47 pF	
32 kHz	15 pF	15 pF	33 pF	33 pF	33 pF	47 pF	
100 kHz	15 pF	15 pF	33 pF	15 pF	15 pF	33 pF	

#### **Medium Frequency Oscillator Option**

This option supports an external crystal in the range of 100 kHz to 4 MHz. Ceramic resonators are also supported in this configuration.

Table 6 shows capacitor values that may be used with a quartz crystal in this mode.

Table 6. Recommended oscillator capacitors for use with the medium frequency oscillator option

Oscillator Frequency	V <sub>DD</sub> = 2.7 to 4.5 V						
Oscillator Frequency	Lower Limit	Optimal Value	Upper Limit				
100 kHz	33 pF	33 pF	47 pF				
1 MHz	15 pF	15 pF	33 pF				
4 MHz	15 pF	15 pF	33 pF				

#### **High Frequency Oscillator Option**

This option supports an external crystal in the range of 4 to 20 MHz. Ceramic resonators are also supported in this configuration.

Table 7 shows capacitor values that may be used with a quartz crystal in this mode.

Table 7. Recommended oscillator capacitors for use with the high frequency oscillator option

Oscillator		V <sub>DD</sub> = 2.7 to 4.5 V		V <sub>DD</sub> = 4.5 to 6.0 V				
Frequency	Lower Limit	Optimal Value	Upper Limit	Lower Limit	Optimal Value	Upper Limit		
4 MHz	15 pF	33 pF	47 pF	15 pF	33 pF	68 pF		
8 MHz	15 pF	15 pF	33 pF	15 pF	33 pF	47 pF		
16 MHz	_	-	-	15 pF	15 pF	33 pF		
20 MHz	-	-	-	15 pF	15 pF	33 pF		

#### On-Chip RC Oscillator Option

The on-chip RC oscillator option has a typical frequency of 6 MHz and can be divided down for slower operation through the use of the DIVM register. Note that some devices have 10% tolerance and others 25% tolerance at this time. For on-chip oscillator tolerance see Electrical Characteristics table. A clock output on the X2/P2.0 pin may be enabled when the on-chip RC oscillator is used.

#### **External Clock Input Option**

In this configuration, the processor clock is input from an external source driving the X1/P2.1 pin. The rate may be from 0 Hz up to 20 MHz when  $V_{DD}$  is above 4.5 V and up to 10 MHz when  $V_{DD}$  is below 4.5 V. When the external clock input mode is used, the X2/P2.0

pin may be used as a standard port pin. A clock output on the X2/P2.0 pin may be enabled when the external clock input is used.

#### **Clock Output**

The 87LPC762 supports a clock output function when either the on-chip RC oscillator or external clock input options are selected. This allows external devices to synchronize to the 87LPC762. When enabled, via the ENCLK bit in the P2M1 register, the clock output appears on the X2/CLKOUT pin whenever the on-chip oscillator is running, including in Idle mode. The frequency of the clock output is 1/6 of the CPU clock rate. If the clock output is not needed in Idle mode, it may be turned off prior to entering Idle, saving additional power. The clock output may also be enabled when the external clock input option is selected.

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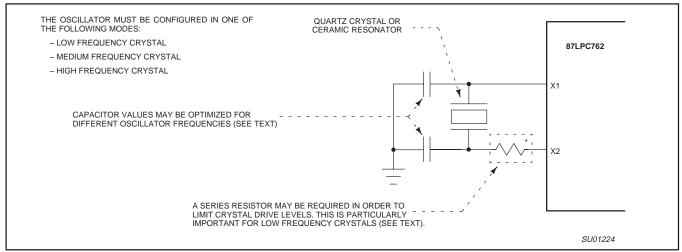


Figure 16. Using the Crystal Oscillator

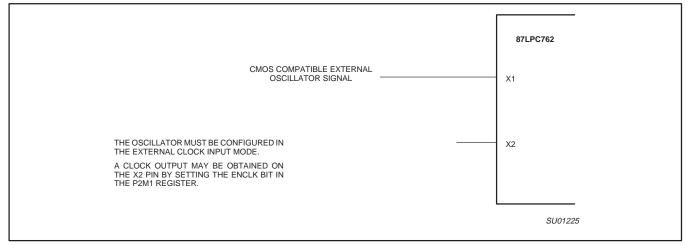


Figure 17. Using an External Clock Input

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For correct activation of Brownout Detect, the  $V_{DD}$  fall time must be no faster than 50 mV/ $\mu$ s. When  $V_{DD}$  is restored, is should not rise faster than 2 mV/ $\mu$ s in order to insure a proper reset.

The brownout voltage (2.5 V or 3.8 V) is selected via the BOV bit in the EPROM configuration register UCFG1. When unprogrammed (BOV = 1), the brownout detect voltage is 2.5 V. When programmed (BOV = 0), the brownout detect voltage is 3.8 V.

If the Brownout Detect function is not required in an application, it may be disabled, thus saving power. Brownout Detect is disabled by setting the control bit BOD in the AUXR1 register (AUXR1.6).

#### **Power On Detection**

The Power On Detect has a function similar to the Brownout Detect, but is designed to work as power comes up initially, before the power supply voltage reaches a level where Brownout Detect can work. When this feature is activated, the POF flag in the PCON register is set to indicate an initial power up condition. The POF flag will remain set until cleared by software.

#### **Power Reduction Modes**

The 87LPC762 supports Idle and Power Down modes of power reduction.

#### Idle Mode

The Idle mode leaves peripherals running in order to allow them to activate the processor when an interrupt is generated. Any enabled interrupt source or Reset may terminate Idle mode. Idle mode is entered by setting the IDL bit in the PCON register (see Figure 19).

#### **Power Down Mode**

The Power Down mode stops the oscillator in order to absolutely minimize power consumption. Power Down mode is entered by setting the PD bit in the PCON register (see Figure 19).

The processor can be made to exit Power Down mode via Reset or one of the interrupt sources shown in Table 8. This will occur if the interrupt is enabled and its priority is higher than any interrupt currently in progress.

In Power Down mode, the power supply voltage may be reduced to the RAM keep-alive voltage  $V_{RAM}.$  This retains the RAM contents at the point where Power Down mode was entered. SFR contents are not guaranteed after  $V_{DD}$  has been lowered to  $V_{RAM},$  therefore it is recommended to wake up the processor via Reset in this case.  $V_{DD}$  must be raised to within the operating range before the Power Down mode is exited. Since the watchdog timer has a separate oscillator, it may reset the processor upon overflow if it is running during Power Down.

Note that if the Brownout Detect reset is enabled, the processor will be put into reset as soon as  $V_{DD}$  drops below the brownout voltage. If Brownout Detect is configured as an interrupt and is enabled, it will wake up the processor from Power Down mode when  $V_{DD}$  drops below the brownout voltage.

When the processor wakes up from Power Down mode, it will start the oscillator immediately and begin execution when the oscillator is stable. Oscillator stability is determined by counting 1024 CPU clocks after start-up when one of the crystal oscillator configurations is used, or 256 clocks after start-up for the internal RC or external clock input configurations.

Some chip functions continue to operate and draw power during Power Down mode, increasing the total power used during Power Down. These include the Brownout Detect, Watchdog Timer, and Comparators.

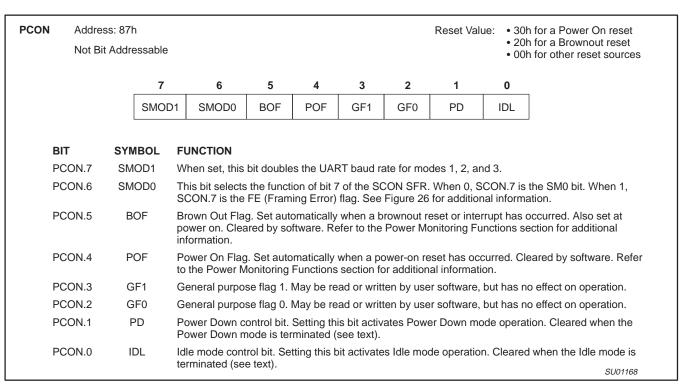


Figure 19. Power Control Register (PCON)

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Table 8. Sources of Wakeup from Power Down Mode

Wakeup Source	Conditions
External Interrupt 0 or 1	The corresponding interrupt must be enabled.
Keyboard Interrupt	The keyboard interrupt feature must be enabled and properly set up. The corresponding interrupt must be enabled.
Comparator 1 or 2	The comparator(s) must be enabled and properly set up. The corresponding interrupt must be enabled.
Watchdog Timer Reset	The watchdog timer must be enabled via the WDTE bit in the UCFG1 EPROM configuration byte.
Watchdog Timer Interrupt	The WDTE bit in the UCFG1 EPROM configuration byte must not be set. The corresponding interrupt must be enabled.
Brownout Detect Reset	The BOD bit in AUXR1 must not be set (brownout detect not disabled). The BOI bit in AUXR1 must not be set (brownout interrupt disabled).
Brownout Detect Interrupt	The BOD bit in AUXR1 must not be set (brownout detect not disabled). The BOI bit in AUXR1 must be set (brownout interrupt enabled). The corresponding interrupt must be enabled.
Reset Input	The external reset input must be enabled.

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#### Mode 0

Putting either Timer into Mode 0 makes it look like an 8048 Timer, which is an 8-bit Counter with a divide-by-32 prescaler. Figure 24 shows Mode 0 operation.

In this mode, the Timer register is configured as a 13-bit register. As the count rolls over from all 1s to all 0s, it sets the Timer interrupt flag TFn. The count input is enabled to the Timer when TRn = 1 and either GATE = 0 or  $\overline{\text{INTn}}$  = 1. (Setting GATE = 1 allows the Timer to be controlled by external input  $\overline{\text{INTn}}$ , to facilitate pulse width

measurements). TRn is a control bit in the Special Function Register TCON (Figure 23). The GATE bit is in the TMOD register.

The 13-bit register consists of all 8 bits of THn and the lower 5 bits of TLn. The upper 3 bits of TLn are indeterminate and should be ignored. Setting the run flag (TRn) does not clear the registers.

Mode 0 operation is the same for Timer 0 and Timer 1. See Figure 24. There are two different GATE bits, one for Timer 1 (TMOD.7) and one for Timer 0 (TMOD.3).

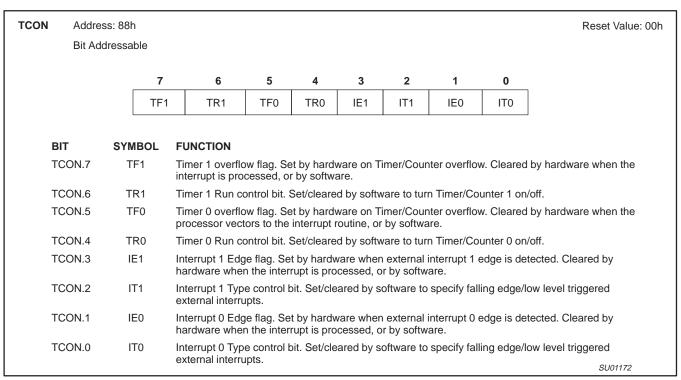


Figure 23. Timer/Counter Control Register (TCON)

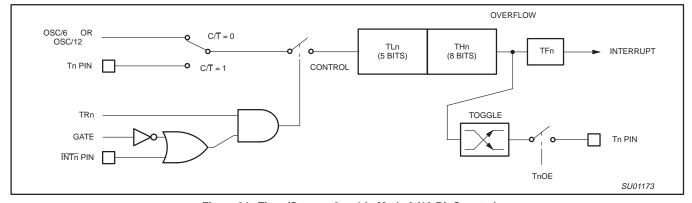


Figure 24. Timer/Counter 0 or 1 in Mode 0 (13-Bit Counter)

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#### Mode 1

Mode 1 is the same as Mode 0, except that all 16 bits of the timer register (THn and TLn) are used. See Figure 25

#### Mode 2

Mode 2 configures the Timer register as an 8-bit Counter (TL1) with automatic reload, as shown in Figure 26. Overflow from TLn not only sets TFn, but also reloads TLn with the contents of THn, which must be preset by software. The reload leaves THn unchanged. Mode 2 operation is the same for Timer 0 and Timer 1.

#### Mode 3

When Timer 1 is in Mode 3 it is stopped. The effect is the same as setting TR1 = 0.

Timer 0 in Mode 3 establishes TL0 and TH0 as two separate 8-bit counters. The logic for Mode 3 on Timer 0 is shown in Figure 27. TL0 uses the Timer 0 control bits: C/T, GATE, TR0 and pin INT0, and TF0. TH0 is locked into a timer function (counting machine cycles) and takes over the use of TR1 and TF1 from Timer 1. Thus, TH0 now controls the "Timer 1" interrupt.

Mode 3 is provided for applications that require an extra 8-bit timer. With Timer 0 in Mode 3, an 87LPC762 can look like it has three Timer/Counters. When Timer 0 is in Mode 3, Timer 1 can be turned on and off by switching it into and out of its own Mode 3. It can still be used by the serial port as a baud rate generator, or in any application not requiring an interrupt.

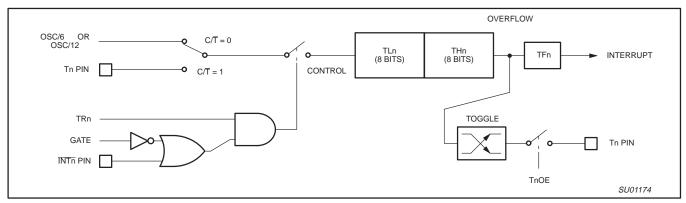


Figure 25. Timer/Counter 0 or 1 in Mode 1 (16-Bit Counter)

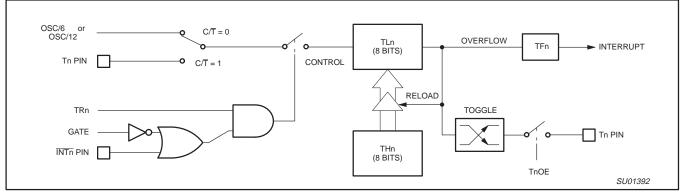


Figure 26. Timer/Counter 0 or 1 in Mode 2 (8-Bit Auto-Reload)

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#### Serial Port Control Register (SCON)

The serial port control and status register is the Special Function Register SCON, shown in Figure 28. This register contains not only the mode selection bits, but also the 9th data bit for transmit and receive (TB8 and RB8), and the serial port interrupt bits (TI and RI).

The Framing Error bit (FE) allows detection of missing stop bits in the received data stream. The FE bit shares the bit position SCON.7 with the SM0 bit. Which bit appears in SCON at any particular time is determined by the SMOD0 bit in the PCON register. If SMOD0 = 0, SCON.7 is the SM0 bit. If SMOD0 = 1, SCON.7 is the FE bit. Once set, the FE bit remains set until it is cleared by software. This allows detection of framing errors for a group of characters without the need for monitoring it for every character individually.

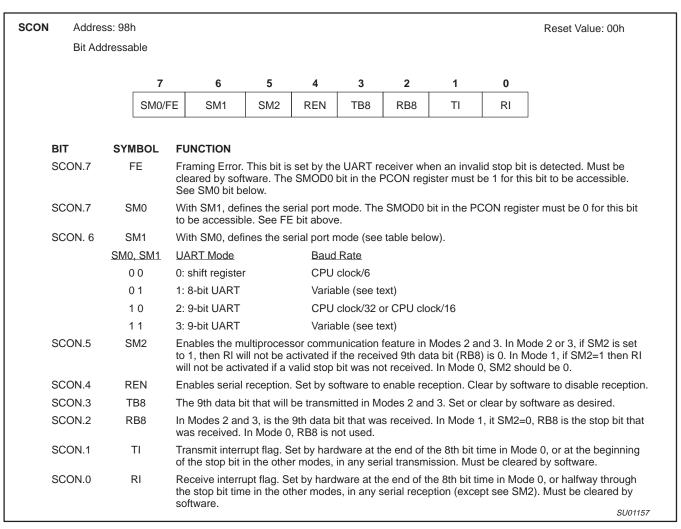


Figure 28. Serial Port Control Register (SCON)

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Table 10. Baud Rates, Timer Values, and CPU Clock Frequencies for SMOD1 = 1

Timer Count	Baud Rate									
Timer Count	2400	4800	9600	19.2 k	38.4 k	57.6 k	115.2 k			
-1	0.2304	0.4608	0.9216	* 1.8432	* 3.6864	5.5296	* 11.0592			
-2	0.4608	0.9216	* 1.8432	* 3.6864	* 7.3728	* 11.0592	-			
-3	0.6912	1.3824	2.7648	5.5296	* 11.0592	16.5888	-			
-4	0.9216	* 1.8432	* 3.6864	* 7.3728	* 14.7456	_	-			
-5	1.1520	2.3040	4.6080	9.2160	* 18.4320	_	-			
-6	1.3824	2.7648	5.5296	* 11.0592	_	_	-			
-7	1.6128	3.2256	6.4512	12.9024	-	-	-			
-8	* 1.8432	* 3.6864	* 7.3728	* 14.7456	-	-	-			
-9	2.0736	4.1472	8.2944	16.5888	-	_	-			
-10	2.3040	4.6080	9.2160	* 18.4320	_	_	-			
-11	2.5344	5.0688	10.1376	_	_	_	-			
-12	2.7648	5.5296	* 11.0592	-	_	_	-			
-13	2.9952	5.9904	11.9808	-	-	_	-			
-14	3.2256	6.4512	12.9024	-	-	-	-			
-15	3.4560	6.9120	13.8240	-	-	_	-			
-16	* 3.6864	* 7.3728	* 14.7456	_	_	_	-			
-17	3.9168	7.8336	15.6672	_	_	_	-			
-18	4.1472	8.2944	16.5888	-	-	_	-			
-19	4.3776	8.7552	17.5104	-	-	_	-			
-20	4.6080	9.2160	* 18.4320	-	-	_	-			
-21	4.8384	9.6768	19.3536	-	-	_	-			

#### NOTES TO TABLES 9 AND 10:

- 1. Tables 9 and 10 apply to UART modes 1 and 3 (variable rate modes), and show CPU clock rates in MHz for standard baud rates from 2400 to 115.2k baud.
- 2. Table 9 shows timer settings and CPU clock rates with the SMOD1 bit in the PCON register = 0 (the default after reset), while Table 10 reflects the SMOD1 bit = 1.
- 3. The tables show all potential CPU clock frequencies up to 20 MHz that may be used for baud rates from 9600 baud to 115.2 k baud. Other CPU clock frequencies that would give only lower baud rates are not shown.
- Table entries marked with an asterisk (\*) indicate standard crystal and ceramic resonator frequencies that may be obtained from many sources without special ordering.

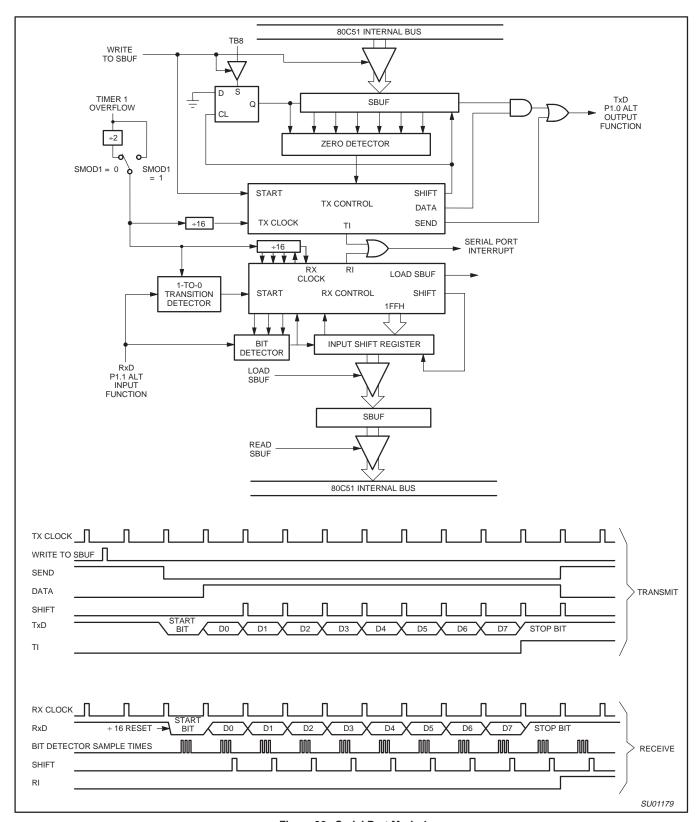


Figure 30. Serial Port Mode 1

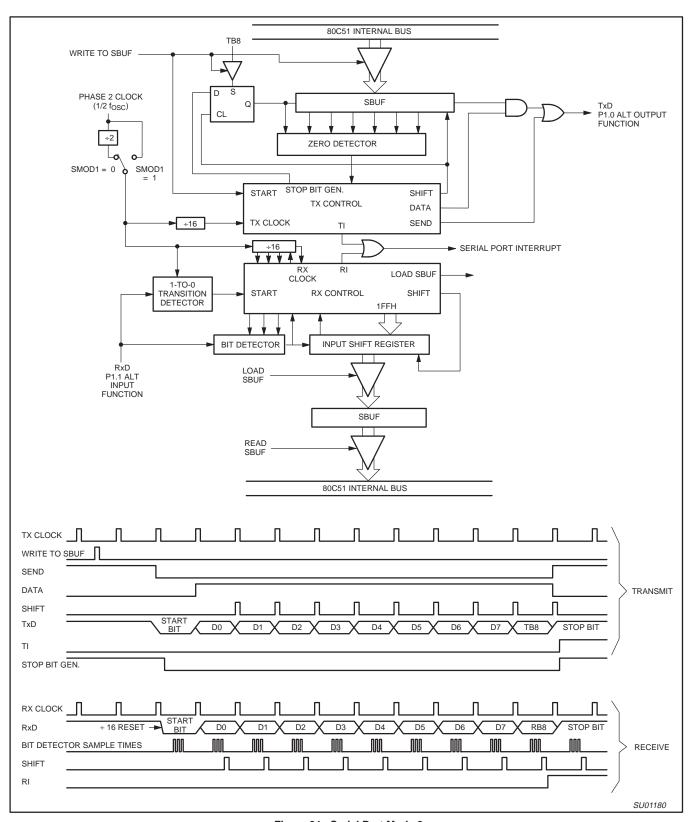


Figure 31. Serial Port Mode 2

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#### Additional Features

The AUXR1 register contains several special purpose control bits that relate to several chip features. AUXR1 is described in Figure 35.

#### Software Reset

The SRST bit in AUXR1 allows software the opportunity to reset the processor completely, as if an external reset or watchdog reset had occurred. If a value is written to AUXR1 that contains a 1 at bit position 3, all SFRs will be initialized and execution will resume at program address 0000. Care should be taken when writing to AUXR1 to avoid accidental software resets.

#### **Dual Data Pointers**

The dual Data Pointer (DPTR) adds to the ways in which the processor can specify the address used with certain instructions. The DPS bit in the AUXR1 register selects one of the two Data Pointers. The DPTR that is not currently selected is not accessible to software unless the DPS bit is toggled.

Specific instructions affected by the Data Pointer selection are:

INC **DPTR**  Increments the Data Pointer by 1.

JMP @A+DPTR Jump indirect relative to DPTR value.

DPTR, #data16 Load the Data Pointer with a 16-bit

 MOVC A, @A+DPTR Move code byte relative to DPTR to the

accumulator.

 MOVX A, @DPTR Move data byte the accumulator to data

memory relative to DPTR.

 MOVX @DPTR. A Move data byte from data memory

relative to DPTR to the accumulator.

Also, any instruction that reads or manipulates the DPH and DPL registers (the upper and lower bytes of the current DPTR) will be affected by the setting of DPS. The MOVX instructions have limited application for the 87LPC762 since the part does not have an external data bus. However, they may be used to access EPROM configuration information (see EPROM Characteristics section).

Bit 2 of AUXR1 is permanently wired as a logic 0. This is so that the DPS bit may be toggled (thereby switching Data Pointers) simply by incrementing the AUXR1 register, without the possibility of inadvertently altering other bits in the register.

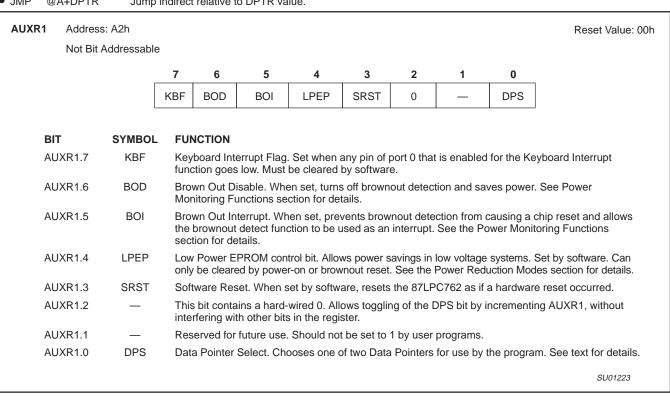


Figure 35. AUXR1 Register

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#### **EPROM Characteristics**

Programming of the EPROM on the 87LPC762 is accomplished with a serial programming method. Commands, addresses, and data are transmitted to and from the device on two pins after programming mode is entered. Serial programming allows easy implementation of in-circuit programming of the 87LPC762 in an application board.

The 87LPC762 contains three signature bytes that can be read and used by an EPROM programming system to identify the device. The signature bytes designate the device as an 87LPC762 manufactured by Philips. The signature bytes may be read by the user program at addresses FC30h, FC31h and FC60h with the MOVC instruction, using the DPTR register for addressing.

A special user data area is also available for access via the MOVC instruction at addresses FCE0h through FCFFh. This "customer code" space is programmed in the same manner as the main code EPROM and may be used to store a serial number, manufacturing date, or other application information.

#### 32-Byte Customer Code Space

A small supplemental EPROM space is reserved for use by the customer in order to identify code revisions, store checksums, add a serial number to each device, or any other desired use. This area exists in the code memory space from addresses FCE0h through FCFFh. Code execution from this space is not supported, but it may be read as data through the use of the MOVC instruction with the appropriate addresses. The memory may be programmed at the same time as the rest of the code memory and UCFG bytes are programmed.

#### **System Configuration Bytes**

A number of user configurable features of the 87LPC762 must be defined at power up and therefore cannot be set by the program after start of execution. Those features are configured through the use of two EPROM bytes that are programmed in the same manner as the EPROM program space. The contents of the two configuration bytes, UCFG1 and UCFG2, are shown in Figures 36 and 37. The values of these bytes may be read by the program through the use of the MOVX instruction at the addresses shown in the figure.

JCFG1 Address: FD00h Unprogrammed Value: FFh										
		7	6	5	4	3	2	1	0	
		WDTE	RPD	PRHI	BOV	CLKR	FOSC2	FOSC1	FOSC0	
BIT	SYM	BOL	FUNC	ION						
UCFG1.7	WD	TE			nable. Whe		ımed (0), d	lisables the	watchdog	timer. The timer may
UCFG1.6	RF	PD		oin disable nly port pin		sables the	reset fund	tion of pin	P1.5, allov	ving it to be used as an
UCFG1.5	PR	RHI	Port re	set high. W	/hen 1, port	s reset to	a high stat	e. When 0,	ports rese	et to a low state.
UCFG1.4	ВС	OV								When 0, the brownout ions section.
UCFG1.3	CL	KR	taking	12 CPU clo		plete as in	the standa			ults in machine cycles ackward compatibility,
UCFG1.2-0	FOSC2-	-FSOC0								tion. Combinations for future use.
	FOSC2-	-FOSC0	Oscilla	or Configu	ration					
	1 1	1 1	Externa	al clock inp	ut on X1 (d	efault setti	ng for an ι	ınprogramı	med part).	
	0 1	1 1	Interna	RC oscilla	ator, 6 MHz	. For tolera	ance, see A	AC Electric	al Charact	eristics table.
	0 1	1 0	Low fre	quency cr	ystal, 20 k⊦	lz to 100 k	Hz.			
	0 (	0 1	Mediur	n frequenc	y crystal or	resonator,	100 kHz t	o 4 MHz.		
	0 (	0 0	High fr	equency cr	ystal or res	onator, 4 N	/IHz to 20	MHz.		
										SU01477

Figure 36. EPROM System Configuration Byte 1 (UCFG1)

### Low power, low price, low pin count (20 pin) microcontroller with 2 kbyte OTP

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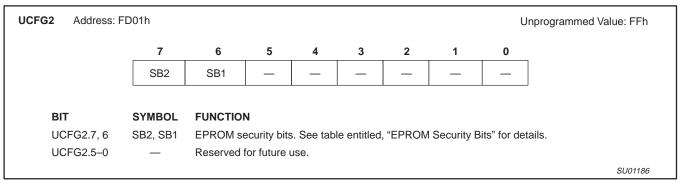


Figure 37. EPROM System Configuration Byte 2 (UCFG2)

#### **Security Bits**

When neither of the security bits are programmed, the code in the EPROM can be verified. When only security bit 1 is programmed, all further programming of the EPROM is disabled. At that point, only security bit 2 may still be programmed. When both security bits are programmed, EPROM verify is also disabled.

Table 11. EPROM Security Bits

SB2	SB1	Protection Description
1	1	Both security bits unprogrammed. No program security features enabled. EPROM is programmable and verifiable.
1	0	Only security bit 1 programmed. Further EPROM programming is disabled. Security bit 2 may still be programmed.
0	1	Only security bit 2 programmed. This combination is not supported.
0	0	Both security bits programmed. All EPROM verification and programming are disabled.

#### **ABSOLUTE MAXIMUM RATINGS**

PARAMETER	RATING	UNIT
Operating temperature under bias	-55 to +125	°C
Storage temperature range	-65 to +150	°C
Voltage on RST/V <sub>PP</sub> pin to V <sub>SS</sub>	0 to +11.0	V
Voltage on any other pin to V <sub>SS</sub>	–0.5 to V <sub>DD</sub> +0.5V	V
Maximum I <sub>OL</sub> per I/O pin	20	mA
Power dissipation (based on package heat transfer, not device power consumption)	1.5	W

#### NOTES:

- Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the AC and DC Electrical Characteristics section of this specification are not implied.
- 2. This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.
- 3. Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to VSS unless otherwise noted.

### Low power, low price, low pin count (20 pin) microcontroller with 2 kbyte OTP

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#### DC ELECTRICAL CHARACTERISTICS

V<sub>DD</sub> = 2.7 V to 6.0 V unless otherwise specified; T<sub>amb</sub> = 0°C to +70°C or -40°C to +85°C, unless otherwise specified.

0)/140.01	24244552	TEST SOUDITIONS				
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>1</sup>	MAX	UNIT
	Daniel and the comment of the commen	5.0 V, 20 MHz <sup>11</sup>		15	25	mA
I <sub>DD</sub>	Power supply current, operating	3.0 V, 10 MHz <sup>11</sup>		4	7	mA
		5.0 V, 20 MHz <sup>11</sup>		6	10	mA
$I_{ID}$	Power supply current, Idle mode	3.0 V, 10 MHz <sup>11</sup>		2	4	mA
		5.0 V <sup>11</sup>		1	10	μΑ
I <sub>PD</sub>	Power supply current, Power Down mode	3.0 V <sup>11</sup>		1	5	μΑ
V <sub>RAM</sub>	RAM keep-alive voltage		1.5			V
		4.0 V < V <sub>DD</sub> < 6.0 V	-0.5		0.2 V <sub>DD</sub> -0.1	V
$V_{IL}$	Input low voltage (TTL input)	2.7 V < V <sub>DD</sub> < 4.0 V	-0.5		0.7	V
V <sub>IL1</sub>	Negative going threshold (Schmitt input)		-0.5		0.3 V <sub>DD</sub>	V
V <sub>IH</sub>	Input high voltage (TTL input)		0.2 V <sub>DD</sub> +0.9		V <sub>DD</sub> +0.5	V
V <sub>IH1</sub>	Positive going threshold (Schmitt input)		0.7V <sub>DD</sub>		V <sub>DD</sub> +0.5	V
HYS	Hysteresis voltage			0.2 V <sub>DD</sub>		V
V <sub>OL</sub>	Output low voltage all ports <sup>5, 9</sup>	$I_{OL} = 3.2 \text{ mA}, V_{DD} = 2.7 \text{ V}$			0.4	V
V <sub>OL1</sub>	Output low voltage all ports <sup>5, 9</sup>	$I_{OL} = 20 \text{ mA}, V_{DD} = 2.7 \text{ V}$			1.0	V
	0	$I_{OH} = -20 \mu A, V_{DD} = 2.7 V$	V <sub>DD</sub> -0.7			V
V <sub>OH</sub>	Output high voltage, all ports <sup>3</sup>	$I_{OH} = -30 \mu A, V_{DD} = 4.5 V$	V <sub>DD</sub> -0.7			V
V <sub>OH1</sub>	Output high voltage, all ports <sup>4</sup>	$I_{OH} = -1.0 \text{ mA}, V_{DD} = 2.7 \text{ V}$	V <sub>DD</sub> -0.7			V
C <sub>IO</sub>	Input/Output pin capacitance <sup>10</sup>				15	pF
I <sub>IL</sub>	Logical 0 input current, all ports <sup>8</sup>	V <sub>IN</sub> = 0.4 V			-50	μΑ
ILI	Input leakage current, all ports <sup>7</sup>	$V_{IN} = V_{IL}$ or $V_{IH}$			±2	μΑ
		$V_{IN} = 1.5 \text{ V at } V_{DD} = 3.0 \text{ V}$	-30		-250	μΑ
I <sub>TL</sub>	Logical 1 to 0 transition current, all ports <sup>3, 6</sup>	$V_{IN} = 2.0 \text{ V at } V_{DD} = 5.5 \text{ V}$	-150		-650	μΑ
R <sub>RST</sub>	Internal reset pull-up resistor		40		225	kΩ
V <sub>BOLOW</sub>	Brownout trip voltage with BOV = 1 <sup>12</sup>		2.35		2.69	V
V <sub>BOHI</sub>	Brownout trip voltage with BOV = 0		3.45		3.99	V
V <sub>REF</sub>	Reference voltage		1.11	1.26	1.41	V
t <sub>C</sub> (V <sub>REF</sub> )	Temperature coefficient			tbd	1	ppm/°C
SS	Supply sensitivity			tbd	1	%/V

#### NOTES:

- Typical ratings are not guaranteed. The values listed are at room temperature, 5 V.
- 2. See other Figures for details. Active mode:  $I_{CC(MAX)} = tbd$ ; Idle mode:  $I_{CC(MAX)} = tbd$
- 3. Ports in quasi-bidirectional mode with weak pull-up (applies to all port pins with pull-ups). Does not apply to open drain pins.
- 4. Ports in PUSH-PULL mode. Does not apply to open drain pins.
- 5. In all output modes except high impedance mode.
- Port pins source a transition current when used in quasi-bidirectional mode and externally driven from 1 to 0. This current is highest when V<sub>IN</sub> is approximately 2 V.
- Measured with port in high impedance mode.
- 8. Measured with port in quasi-bidirectional mode.
- 9. Under steady state (non-transient) conditions, I<sub>OL</sub> must be externally limited as follows:

Maximum I<sub>OL</sub> per port pin: 20 mA
Maximum total I<sub>OL</sub> for all outputs: 80 mA
Maximum total I<sub>OH</sub> for all outputs: 5 mA

If  $I_{OL}$  exceeds the test condition,  $V_{OL}$  may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 10. Pin capacitance is characterized but not tested.
- 11. The I<sub>DD</sub>, I<sub>ID</sub>, and I<sub>PD</sub> specifications are measured using an external clock with the following functions disabled: comparators, brownout detect, and watchdog timer. For V<sub>DD</sub> = 3 V, LPEP = 1. Refer to the appropriate figures on the following pages for additional current drawn by each of these functions and detailed graphs for other frequency and voltage combinations.
- 12. Devices initially operating at  $V_{DD} = 2.7 \text{ V}$  or above, and at  $f_{OSC} = 10 \text{ MHz}$  or less, are guaranteed to continue to execute instructions correctly at the brownout trip point. Initial power-on operation below  $V_{DD} = 2.7 \text{ V}$  is not guaranteed.
- 13. Devices initially operating at  $\dot{V}_{DD} = 4.0~V$  or above and at  $f_{OSC} = 20~MHz$  or less are guaranteed to continue to execute instructions correctly at the brownout trip point. Initial power-on operation below  $\dot{V}_{DD} = 4.0~V$  and  $f_{OSC} > 10~MHz$  is not guaranteed.

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#### COMPARATOR ELECTRICAL CHARACTERISTICS

 $V_{DD} = 3.0 \text{ V}$  to 6.0 V unless otherwise specified;  $T_{amb} = 0^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$  or  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ , unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	UNII
V <sub>IO</sub>	Offset voltage comparator inputs <sup>1</sup>				±10	mV
V <sub>CR</sub>	Common mode range comparator inputs		0		V <sub>DD</sub> -0.3	V
CMRR	Common mode rejection ratio <sup>1</sup>				<b>-</b> 50	dB
	Response time			250	500	ns
	Comparator enable to output valid				10	μs
I <sub>IL</sub>	Input leakage current, comparator	$0 < V_{IN} < V_{DD}$			±10	μΑ

#### NOTE:

#### **AC ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 0°C to +70°C or -40°C to +85°C,  $V_{DD}$  = 2.7 V to 6.0 V unless otherwise specified;  $V_{SS}$  = 0 V<sup>1, 2, 3</sup>

CVMDOL	FIGURE	DADAMETED		LIMITS		UNIT
SYMBOL	FIGURE PARAMETER			MIN	MAX	UNII
External Cl	ock					
f <sub>C</sub>	39	Oscillator frequency (V <sub>DD</sub> = 4.0 V to 6.0 V)		0	20	MHz
f <sub>C</sub>	39	Oscillator frequency (V <sub>DD</sub> = 2.7 V to 6.0 V)		0	10	MHz
t <sub>C</sub>	39	Clock period and CPU timing cycle		1/f <sub>C</sub>		ns
f <sub>CTOL</sub>		On-chip RC oscillator tolerance. Applies to P87LPC762BDH only. <sup>5</sup>		-	10	%
f <sub>CTOL</sub>		On-chip RC oscillator tolerance. All other devices.		_	25	%
t <sub>CHCX</sub>	39	Clock high-time <sup>4</sup>	f <sub>OSC</sub> = 20 MHz	20		ns
			f <sub>OSC</sub> = 10 MHz	40		ns
t <sub>CLCX</sub>	39	Clock low-time <sup>4</sup>	f <sub>OSC</sub> = 20 MHz	20		ns
			f <sub>OSC</sub> = 10 MHz	40		ns
Shift Regis	ter	-	_	_	_	
t <sub>XLXL</sub>	38	Serial port clock cycle time		6t <sub>C</sub>		ns
t <sub>QVXH</sub>	38	Output data setup to clock rising edge		5t <sub>C</sub> – 133		ns
t <sub>XHQX</sub>	38	Output data hold after clock rising edge		1t <sub>C</sub> – 80		ns
t <sub>XHDV</sub>	38	Input data setup to clock rising edge			5t <sub>C</sub> – 133	ns
t <sub>XHDX</sub>	38	Input data hold after clock rising edge		0		ns

#### NOTES

- 1. Parameters are valid over operating temperature range unless otherwise specified.
- 2. Load capacitance for all outputs = 80 pF.
- 3. Parts are guaranteed to operate down to 0 Hz.
- 4. Applies only to an external clock source, not when a crystal is connected to the X1 and X2 pins.
- 5. For availability of other devices with this specification, please contact Philips sales office.

<sup>1.</sup> This parameter is guaranteed by characterization, but not tested in production.